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BIPOLAR ANALOG INTEGRATED CIRCUIT

μ PC8204TK

VARIABLE GAIN AMPLIFIER FOR TRANSMITTER AGC

DESCRIPTION

The μ PC8204TK is a silicon monolithic integrated circuit designed as variable gain amplifier. The package is 6-pin lead-less minimold suitable for surface mount.

This IC is manufactured using our 30 GHz f_{max} UHS0 (Ultra High Speed Process) silicon bipolar process.

This IC is as same circuit current as conventional μ PC8119T and μ PC8120T, but operates at higher frequency and wider gain control range.

FEATURES

- Gain control range : GCR = 40 dB TYP. @ f = 1.9 GHz
: GCR = 40 dB TYP. @ f = 2.4 GHz
- Maximum power gain : GPMAX = 14.5 dB TYP. @ f = 1.9 GHz
: GPMAX = 14.0 dB TYP. @ f = 2.4 GHz
- Operating frequency : f_{in} = 0.8 to 2.5 GHz
- Supply voltage : V_{CC} = 2.7 to 3.3 V
- High-density surface mounting : 6-pin lead-less minimold package

APPLICATION

- 0.8 to 2.5 GHz transmitter/receiver system (PHS, WLAN and so on)

★ ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μ PC8204TK-E2	μ PC8204TK-E2-A	6-pin lead-less minimold (1511 PKG) (Pb-Free) ^{Note}	6E	<ul style="list-style-type: none">• Embossed tape 8 mm wide• Pin 1, 6 face the perforation side of the tape• Qty 5 kpcs/reel

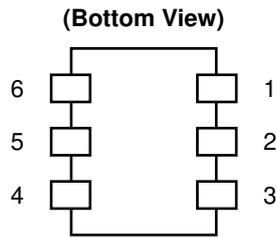
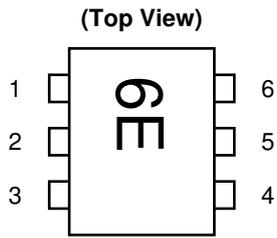
Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μ PC8204TK

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS



Pin No.	Pin Name
1	INPUT
2	GND
3	GND
4	OUTPUT
5	V _{CC}
6	V _{AGC}

VARIABLE GAIN AMPLIFIER PRODUCT LINE-UP

Parameter Part No.	I _{CC} (mA)	0.95 GHz output port matching frequency			1.44 GHz output port matching frequency			1.9 GHz output port matching frequency			2.4 GHz output port matching frequency		
		G _{PMAX} (dB)	G _{CR} (dB)	NF (dB)	G _{PMAX} (dB)	G _{CR} (dB)	NF (dB)	G _{PMAX} (dB)	G _{CR} (dB)	NF (dB)	G _{PMAX} (dB)	G _{CR} (dB)	NF (dB)
μPC8204TK	11.5	-	-	-	-	-	-	14.5	40	7.5	14.0	40	7.5
μPC8119T	11.0	12.5	50	8.5	13.0	45	7.5	(12.5)	(22)	(7.2)	-	-	-
μPC8120T	11.0	13.0	50	9.0	13.5	45	7.5	(13.0)	(22)	(7.3)	-	-	-

- Remarks 1.** Typical performance. Please refer to **ELECTRICAL CHARACTERISTICS** in detail. (): reference.
2. To know the associated product, please refer to each latest data sheet.

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1. PIN EXPLANATION

Pin No.	Pin Name	Applied Voltage (V)	Pin Voltage (V) <small>Note</small>	Function and Applications	Internal Equivalent Circuit
1	INPUT	–	1.2	RF input pin. This pin should be coupled with capacitor (example 100 pF) for DC cut. Input return loss can be improved with external impedance matching circuit.	
2 3	GND	0	–	Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. Ground pins must be connected together with wide ground pattern to decrease impedance difference.	
4	OUTPUT	Voltage as same as V_{CC} through external inductor	–	RF output pin. This pin is designed as open collector of high impedance. This pin must be externally equipped with matching circuits.	
5	V_{CC}	2.7 to 3.3	–	Supply voltage pin. This pin must be equipped with bypass capacitor (example 1 000 pF) to minimize its RF impedance.	—
6	V_{AGC}	0 to 3.3	–	Gain control pin.	

Note Pin voltage is measured at $V_{CC} = 3.0\text{ V}$

2. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	V _{CC}	T _A = +25°C, Pin 4, 5	3.6	V
Total Circuit Current	I _{CC}	T _A = +25°C	30	mA
Gain Control Voltage	V _{AGC}	T _A = +25°C	3.6	V
Power Dissipation	P _D	T _A = +85°C Note	203	mW
Operating Ambient Temperature	T _A		-40 to +85	°C
Storage Temperature	T _{stg}		-55 to +150	°C
Input Power	P _{in}		+5	dBm

Note Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB

3. RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Remarks
Supply Voltage	V _{CC}	2.7	3.0	3.3	V	Same voltage should be applied to pin 4 and pin 5.
Operating Ambient Temperature	T _A	-40	+25	+85	°C	
Operating Frequency	f _{in}	0.8	-	2.5	GHz	With external output-matching
Gain Control Voltage	V _{AGC}	0	-	3.3	V	

4. ELECTRICAL CHARACTERISTICS (T_A = +25°C, V_{CC} = V_{out} = 3.0 V, Z_s = Z_L = 50 Ω, external matched output port, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I _{CC}	No signal	8.5	11.5	15.0	mA
Maximum Power Gain	G _{PMAX}	f = 1.9 GHz, P _{in} = -20 dBm f = 2.4 GHz, P _{in} = -20 dBm	11.5 11.0	14.5 14.0	17.5 17.0	dB
Gain Control Range ^{Note}	GCR	f = 1.9 GHz, P _{in} = -20 dBm f = 2.4 GHz, P _{in} = -20 dBm	35 35	40 40	- -	dB
Gain 1 dB Compression Output Power	P _{O(1 dB)}	f = 1.9 GHz, G _{PMAX} f = 2.4 GHz, G _{PMAX}	+2.0 +2.0	+5.0 +5.0	- -	dBm
Input Return Loss	RL _{in}	f = 1.9 GHz, G _{PMAX} f = 2.4 GHz, G _{PMAX}	8 9	11 13	- -	dB
Isolation	ISL	f = 1.9 GHz, G _{PMAX} f = 2.4 GHz, G _{PMAX}	25 25	30 30	- -	dB
Noise Figure	NF	f = 1.9 GHz, G _{PMAX} f = 2.4 GHz, G _{PMAX}	- -	7.5 7.5	10.0 10.0	dB

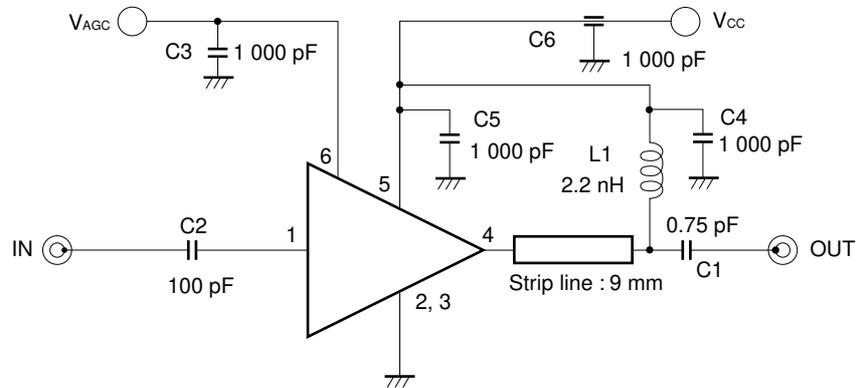
Note Gain control range GCR specification : GCR = G_{PMAX} - G_{PMIN} (dB)

Conditions G_{PMAX}@V_{AGC} = V_{CC}, G_{PMIN}@V_{AGC} = 0 V

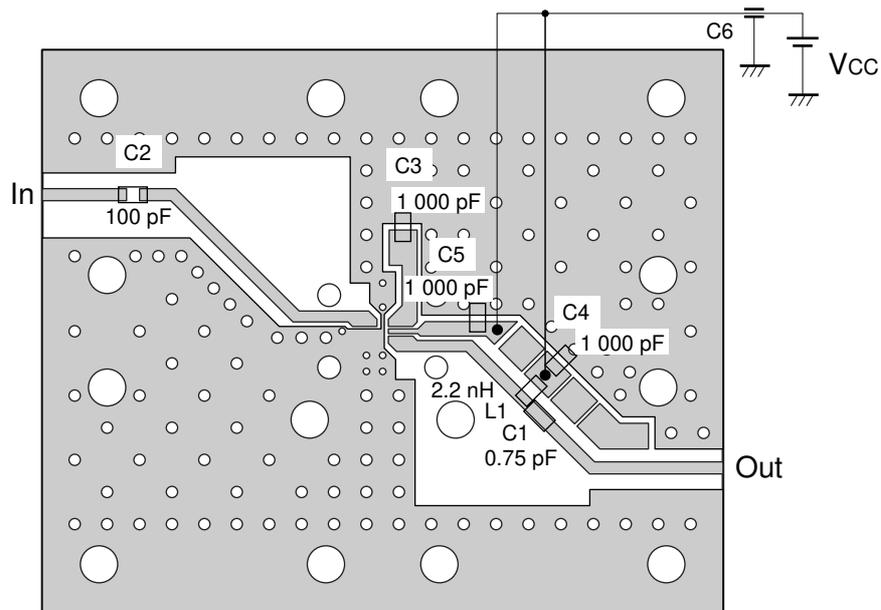
★ 5. TEST CIRCUITS

5.1 f = 1.9 GHz

5.1.1 Test circuit 1



5.1.2 Illustration of the test circuit 1 assembled on evaluation board

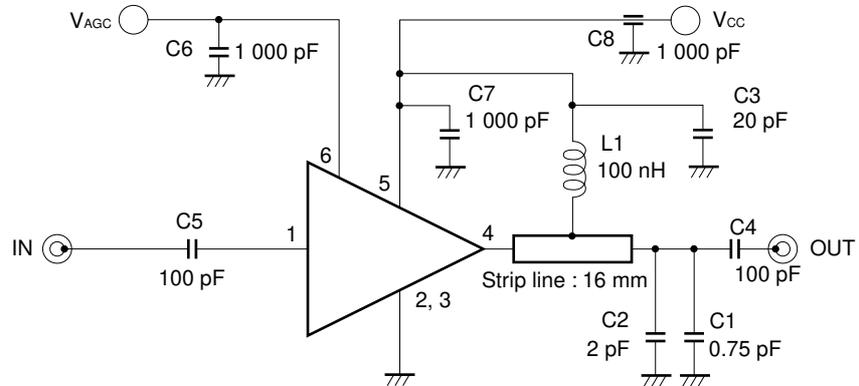


5.1.3 Component list

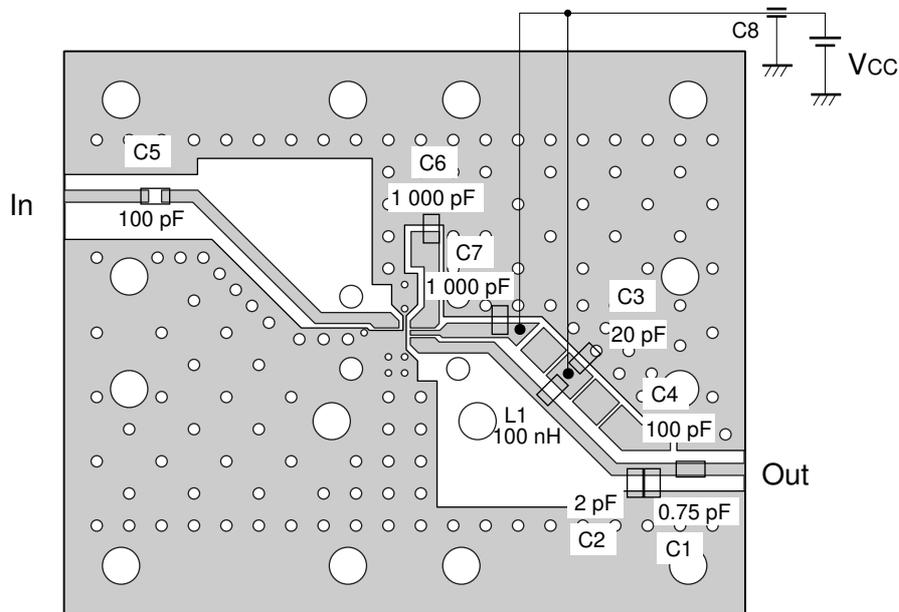
Symbol	Form	Rating	Part Number	Maker
C1	Chip Capacitor	0.75 pF	GRM39	Murata
C2	Chip Capacitor	100 pF	GRM39	Murata
C3, C4	Chip Capacitor	1 000 pF	GRM39	Murata
C5	Chip Capacitor	1 000 pF	GRM40	Murata
C6	Feed-through Capacitor	1 000 pF	DFT301-801X7R102S50	Murata
L1	Chip Inductor	2.2 nH	LL-2012	TOKO

5.2 $f = 2.4$ GHz

5.2.1 Test circuit 2



5.2.2 Illustration of the test circuit 2 assembled on evaluation board

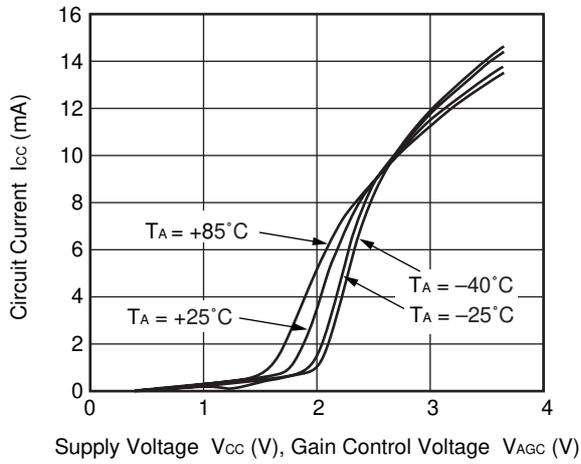


5.2.3 Component list

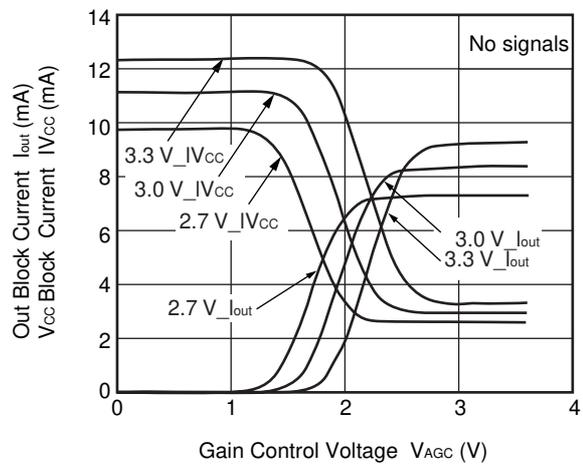
Symbol	Form	Rating	Part Number	Maker
C1	Chip Capacitor	0.75 pF	GRM39	Murata
C2	Chip Capacitor	2 pF	GRM39	Murata
C3	Chip Capacitor	20 pF	GRM39	Murata
C4, C5	Chip Capacitor	100 pF	GRM39	Murata
C6	Chip Capacitor	1 000 pF	GRM39	Murata
C7	Chip Capacitor	1 000 pF	GRM40	Murata
C8	Feed-through Capacitor	1 000 pF	DFT301-801X7R102S50	Murata
L1	Chip Inductor	100 nH	LL-1608	TOKO

★ 6. TYPICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)

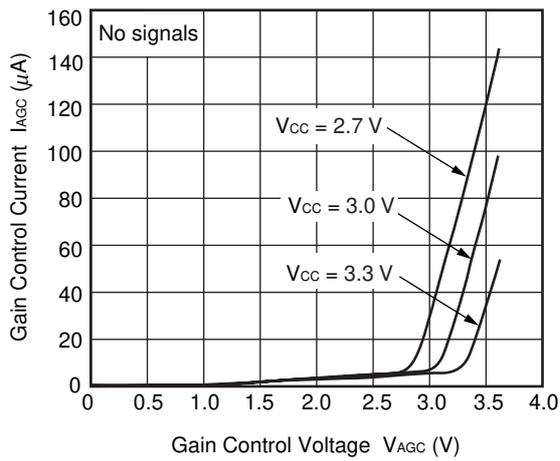
CIRCUIT CURRENT vs. SUPPLY VOLTAGE, GAIN CONTROL VOLTAGE



OUT BLOCK CURRENT AND V_{CC} BLOCK CURRENT vs. GAIN CONTROL VOLTAGE

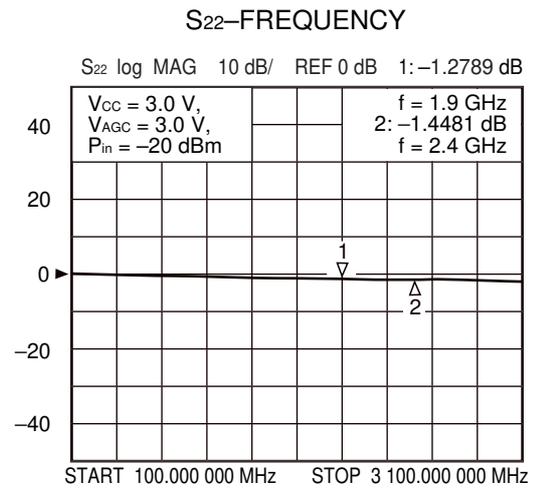
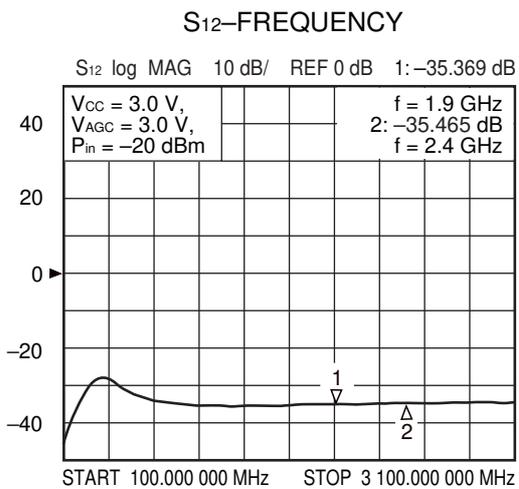
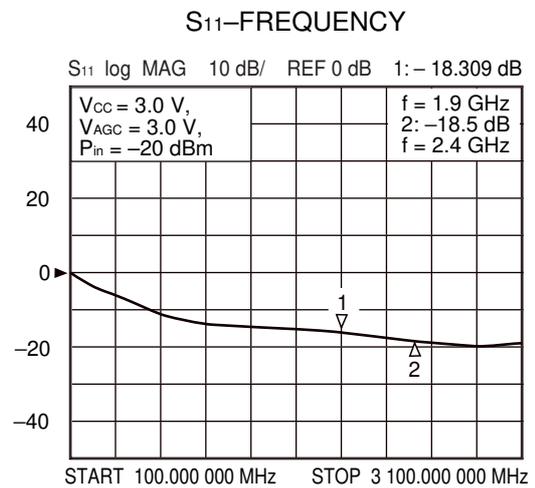
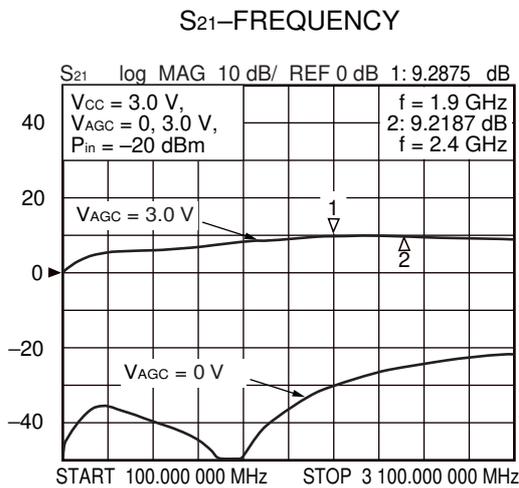
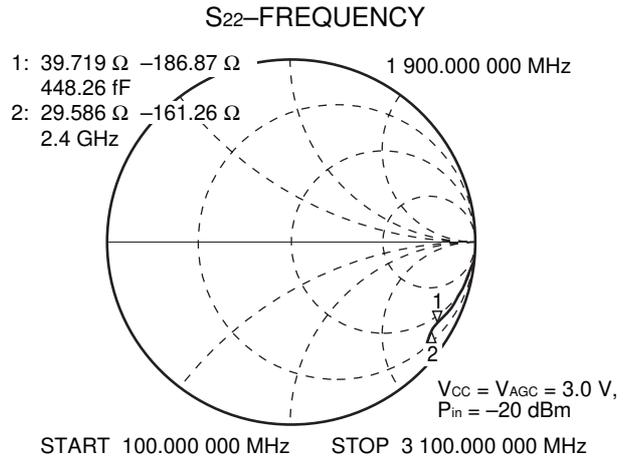
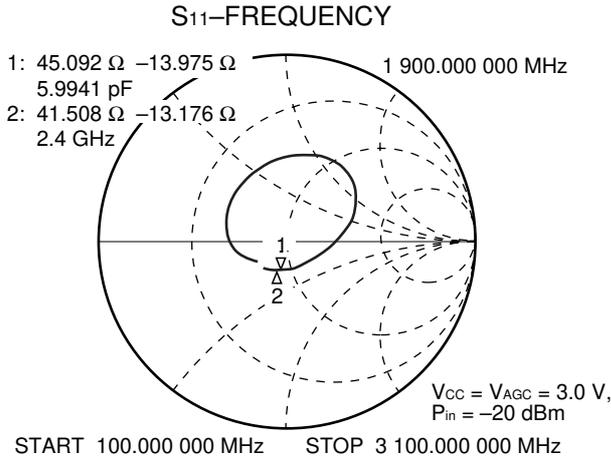


GAIN CONTROL CURRENT vs. GAIN CONTROL VOLTAGE



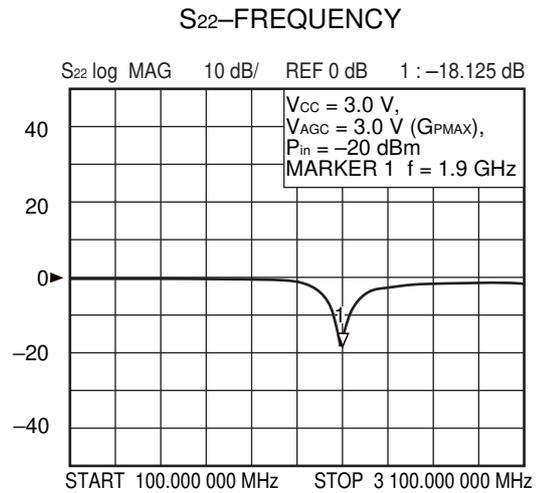
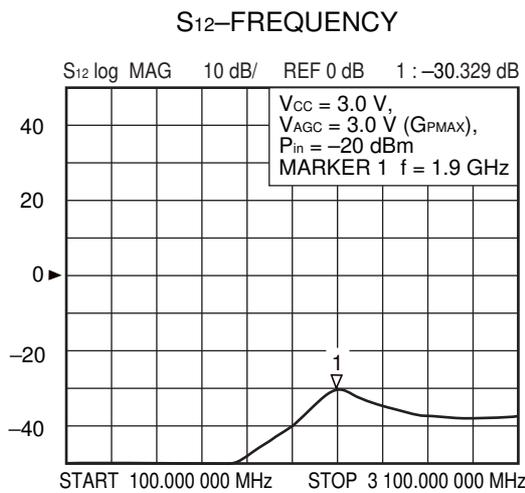
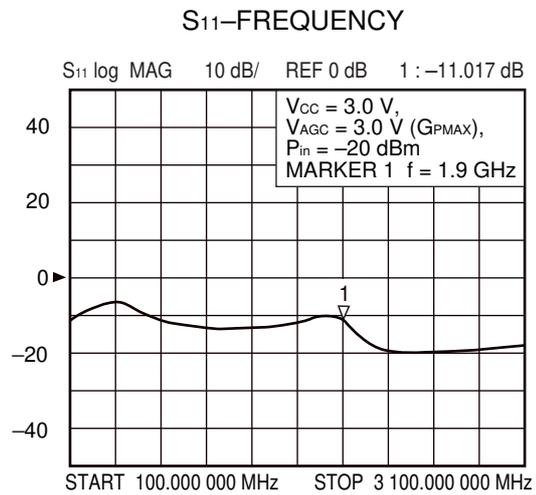
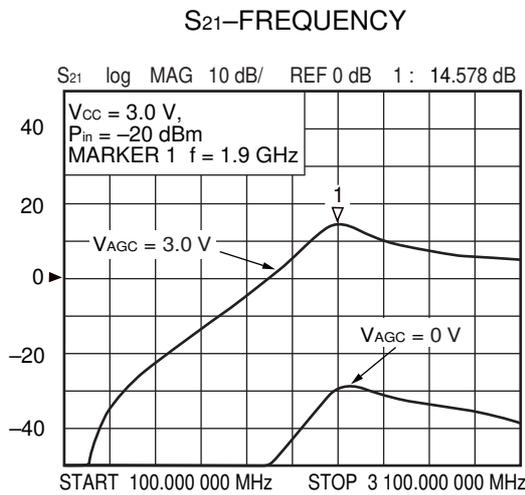
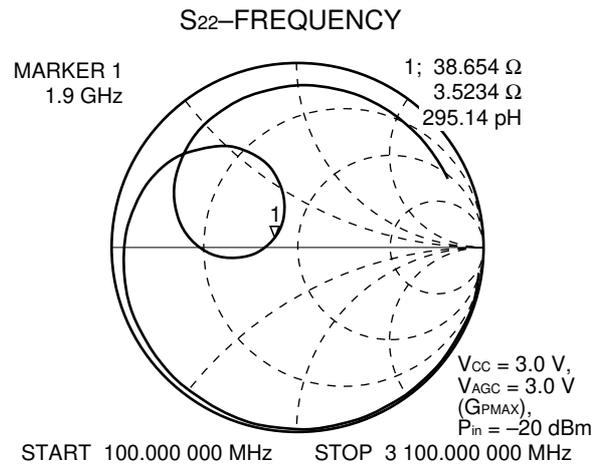
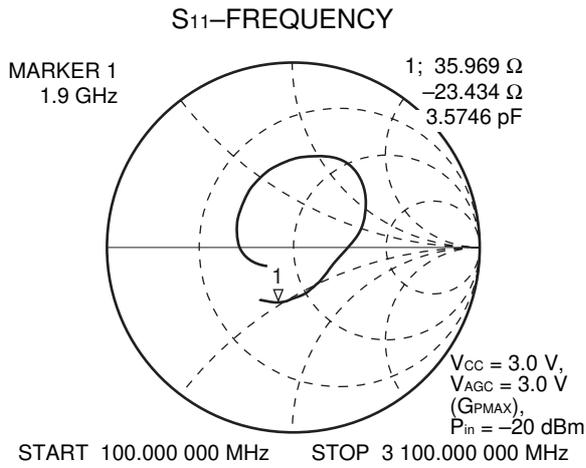
Remark The graphs indicate nominal characteristics.

6.1 Inductor loading with external bias tee at output port



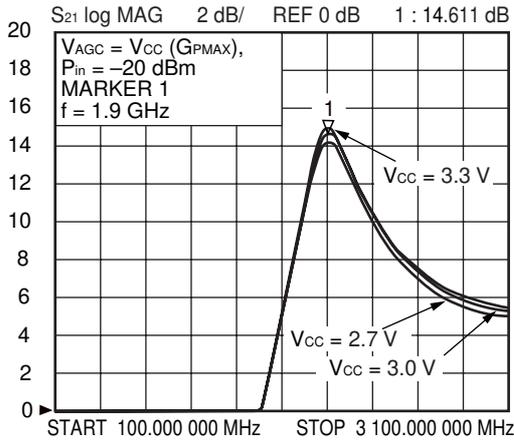
Remark The graphs indicate nominal characteristics.

6. 2 Output port matching at f = 1.9 GHz

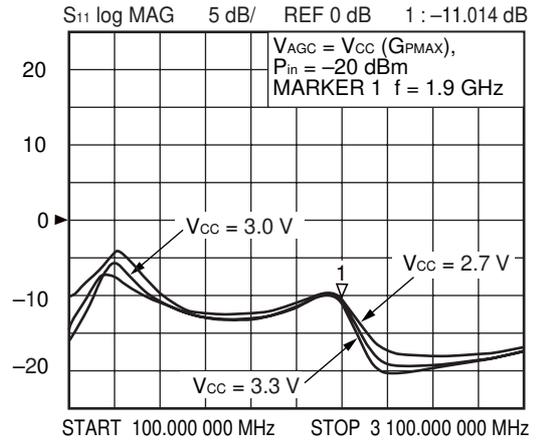


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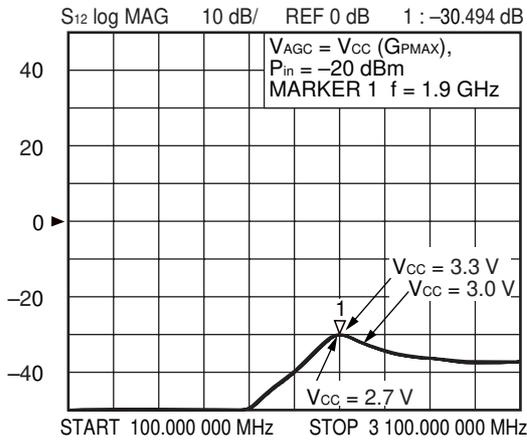
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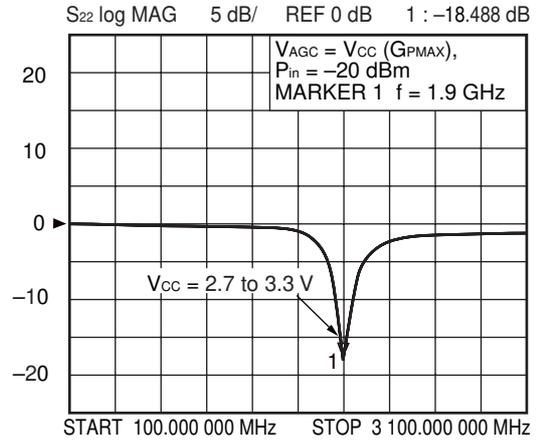
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S12-FREQUENCY

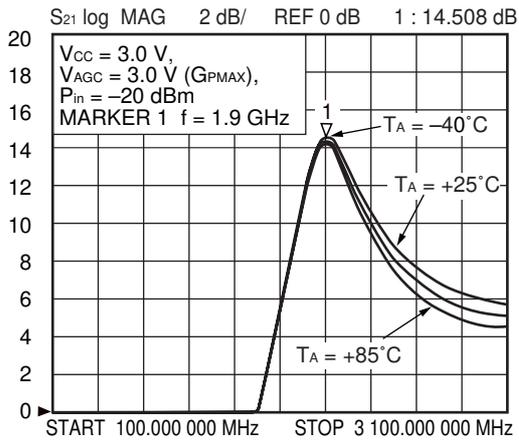


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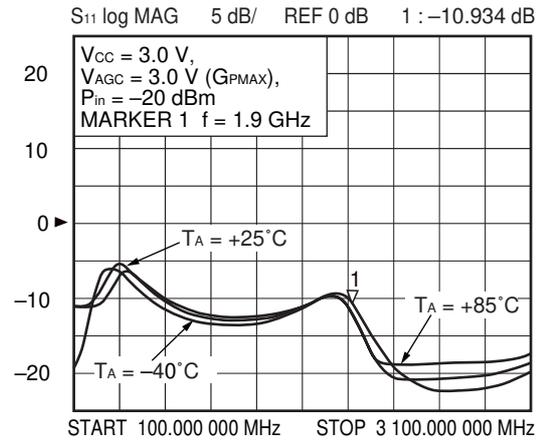


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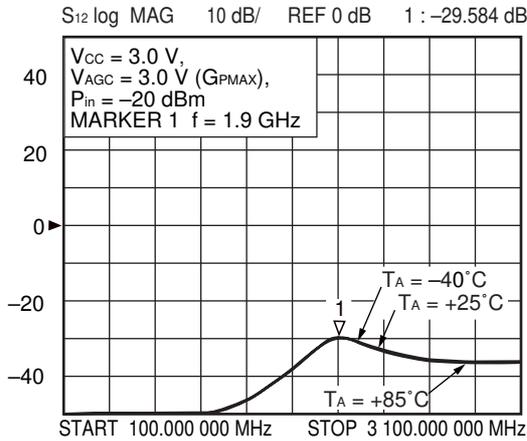
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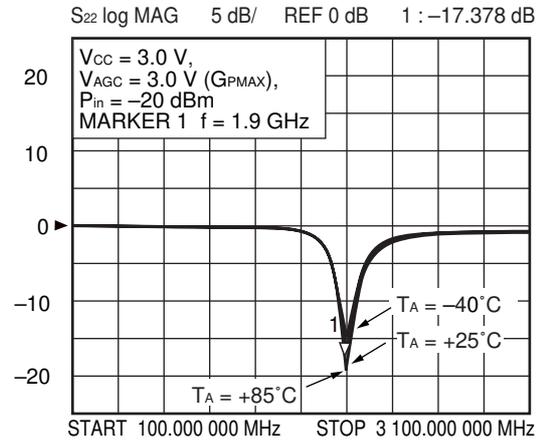
S₁₁-FREQUENCY



S₁₂-FREQUENCY

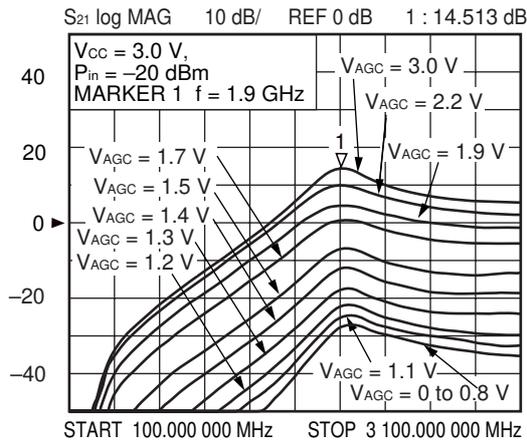


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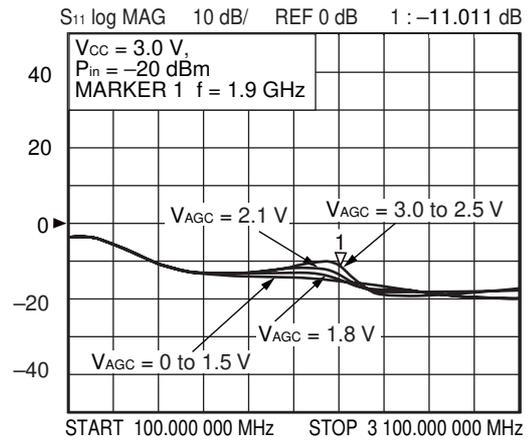


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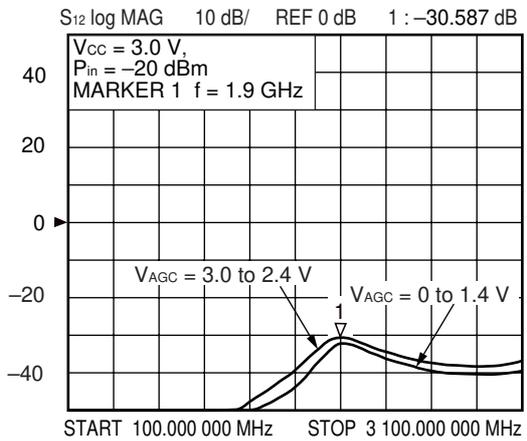
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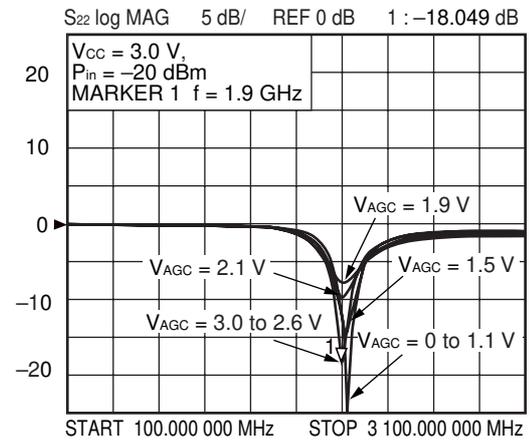
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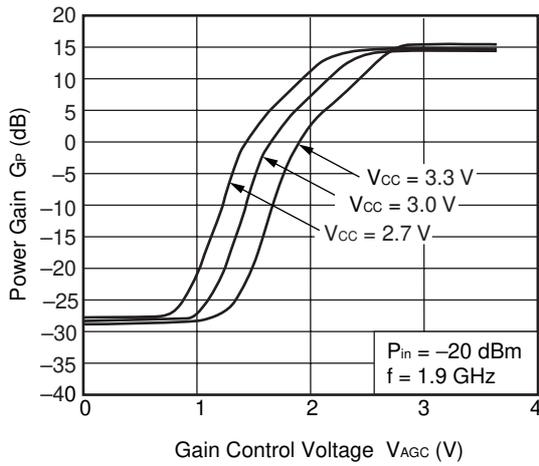


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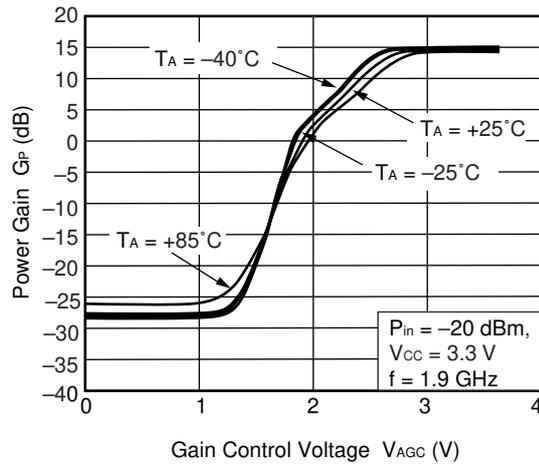


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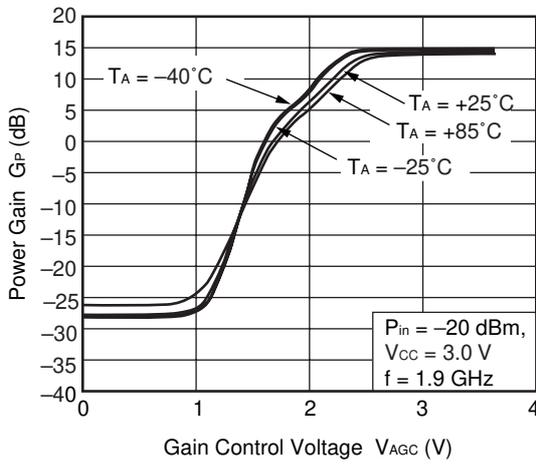
POWER GAIN vs. GAIN CONTROL VOLTAGE



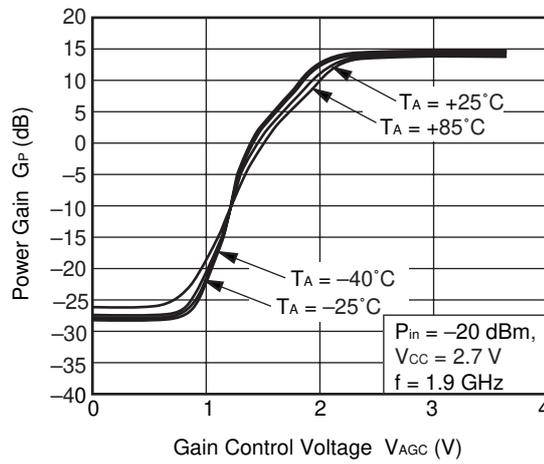
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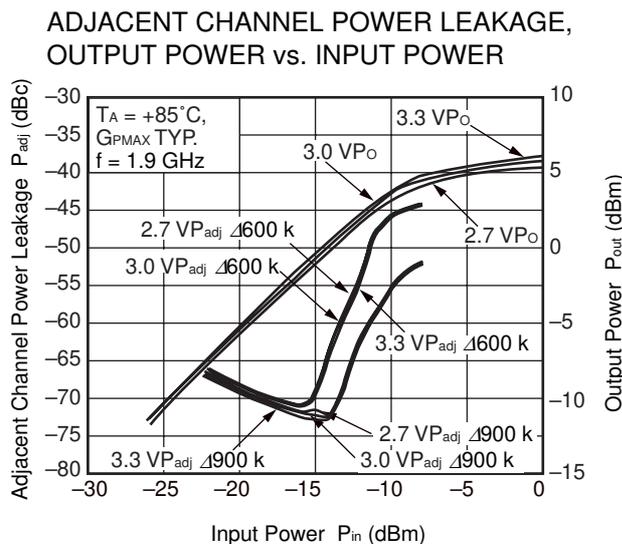
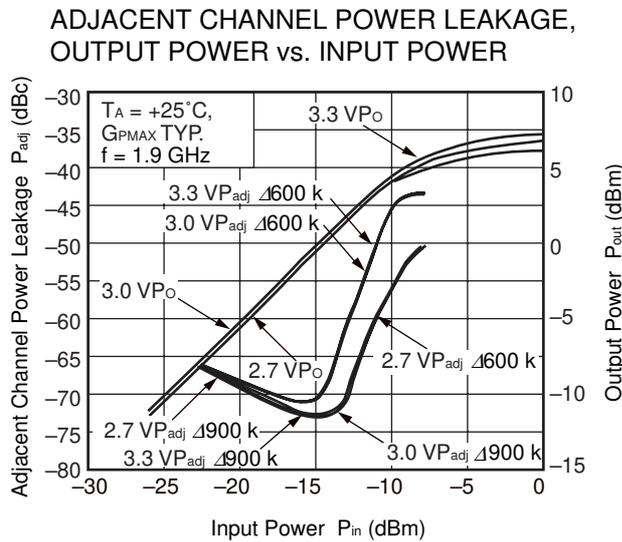
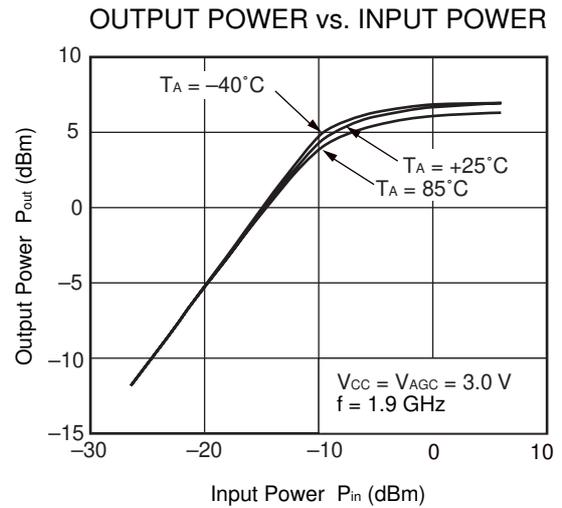
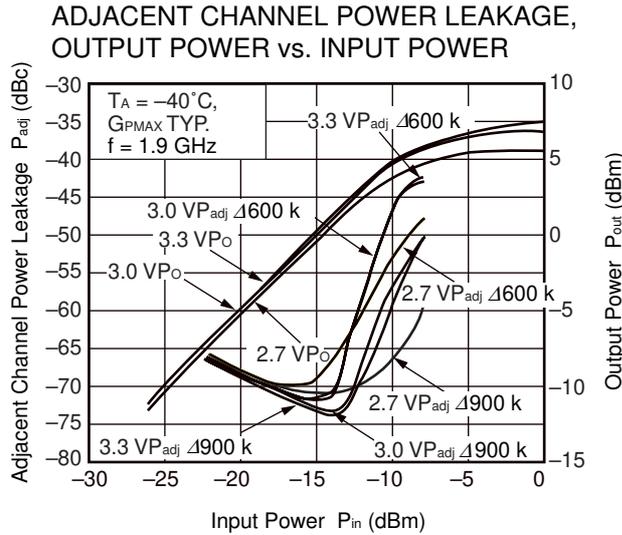
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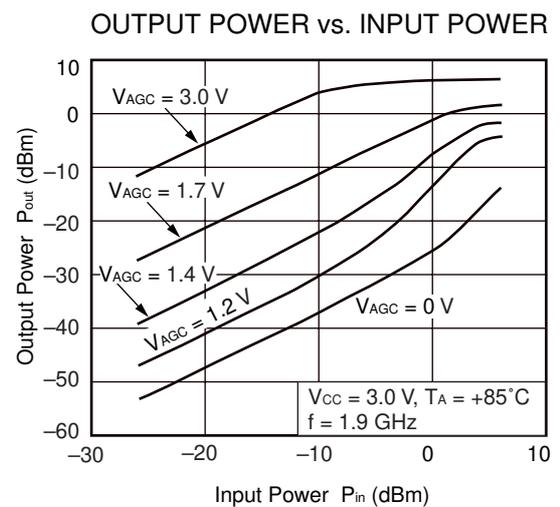
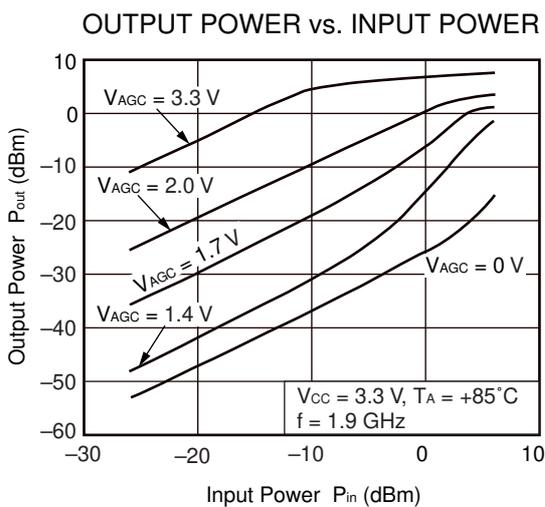
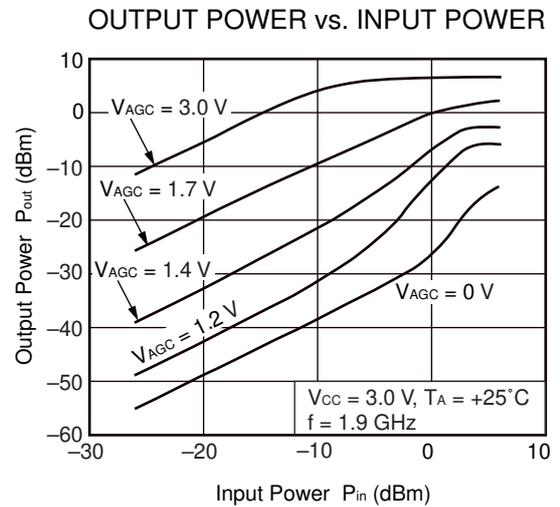
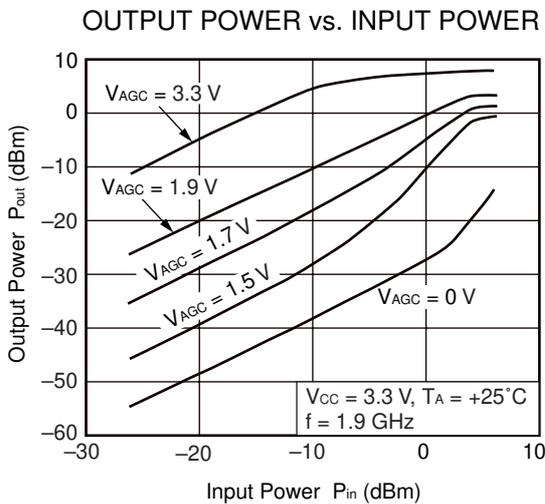
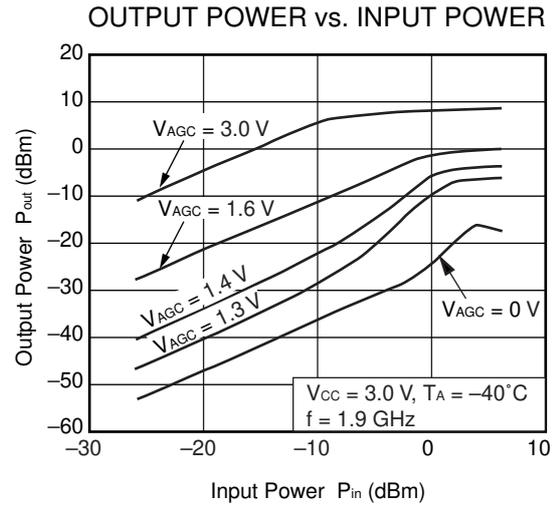
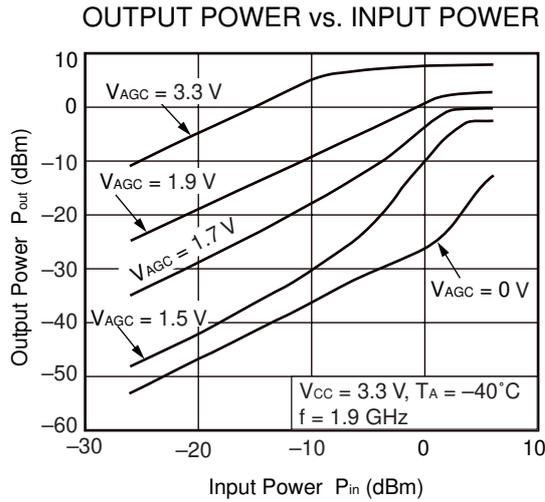
POWER GAIN vs. GAIN CONTROL VOLTAGE



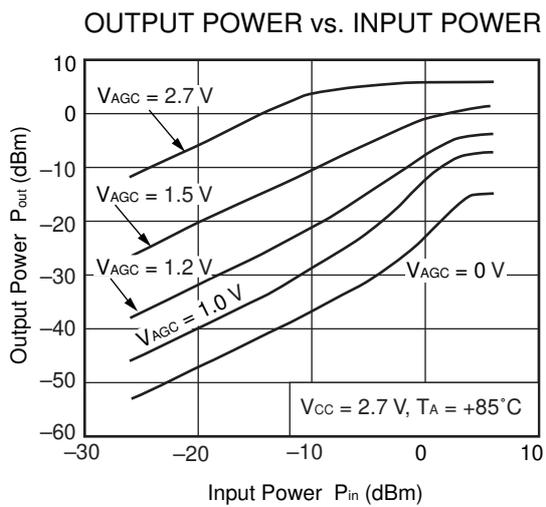
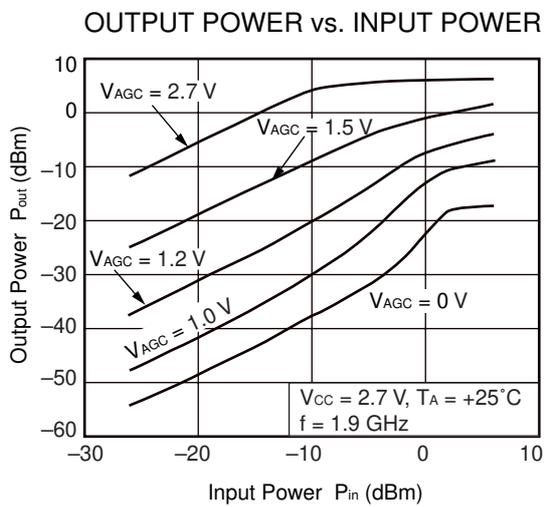
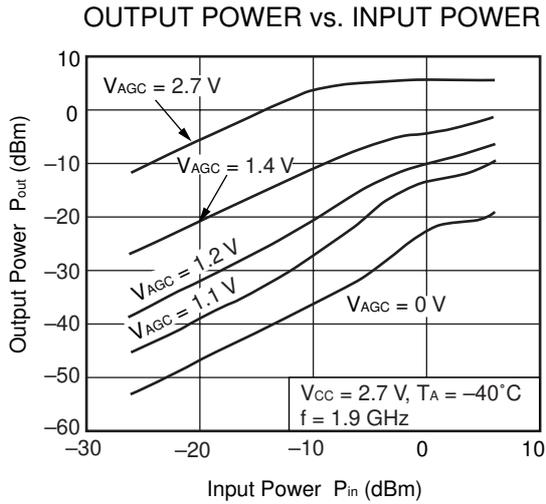
Remark The graphs indicate nominal characteristics.



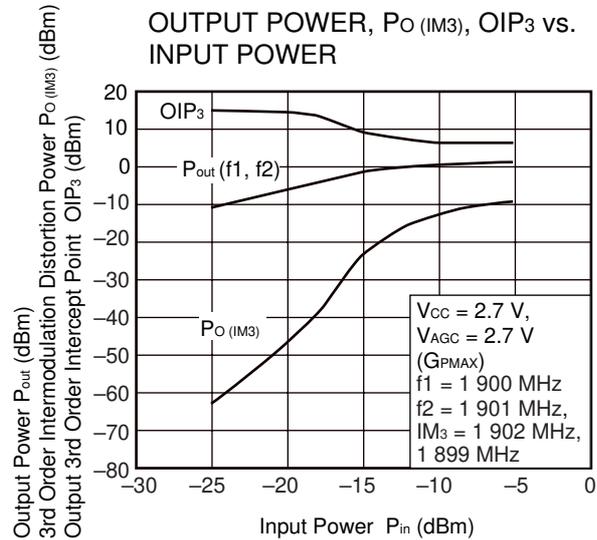
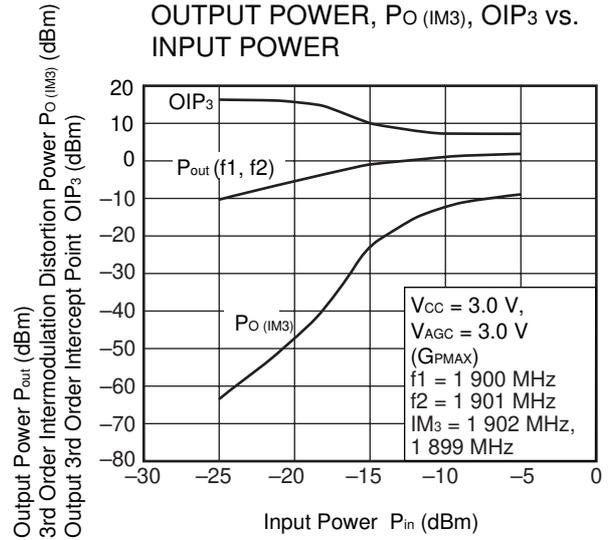
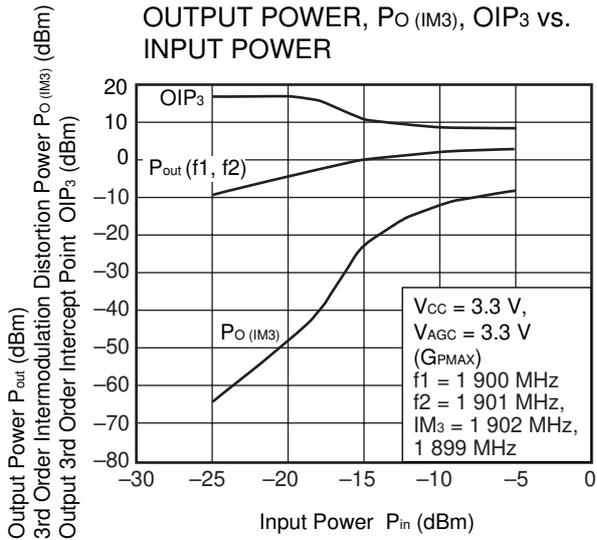
Remark The graphs indicate nominal characteristics.



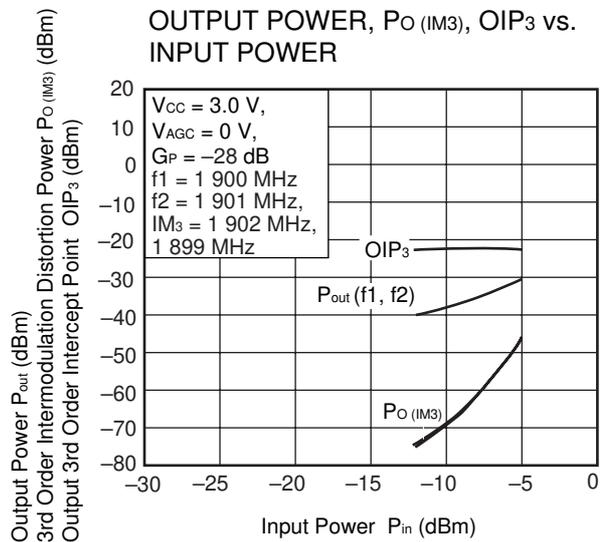
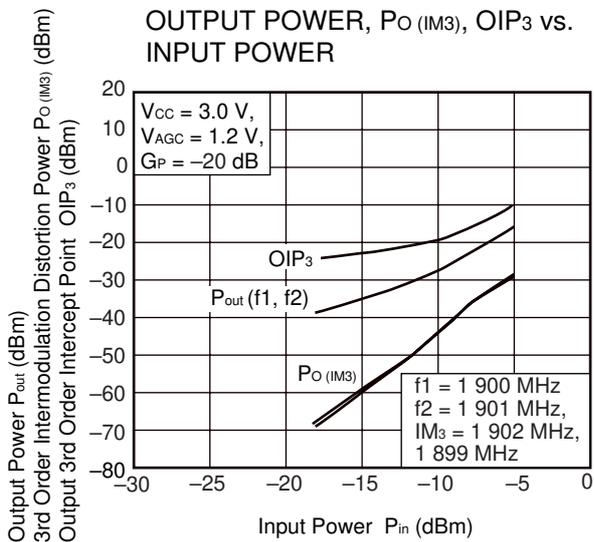
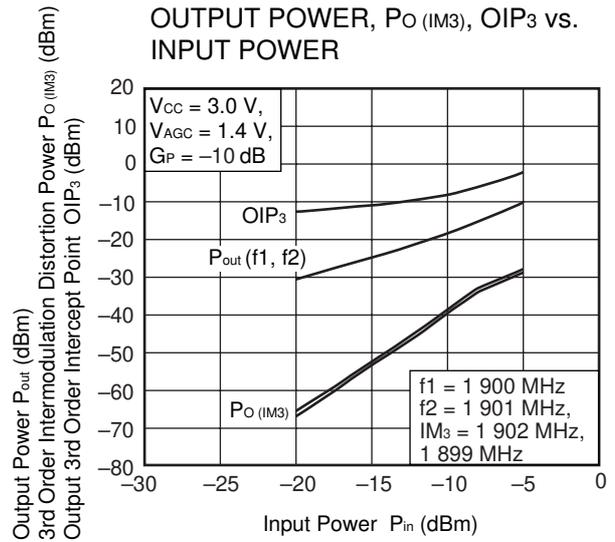
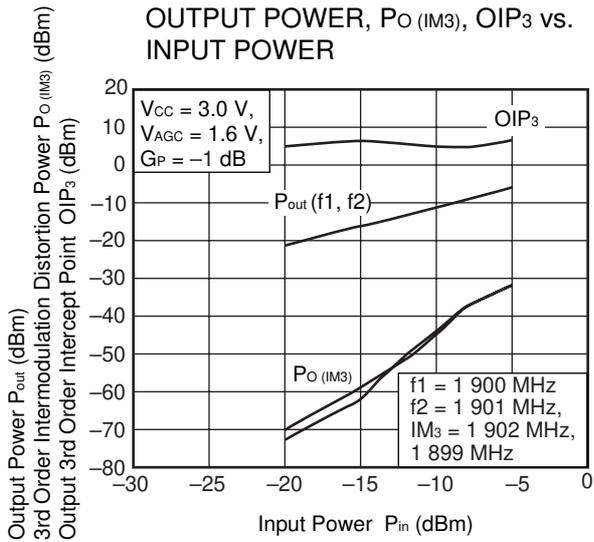
Remark The graphs indicate nominal characteristics.



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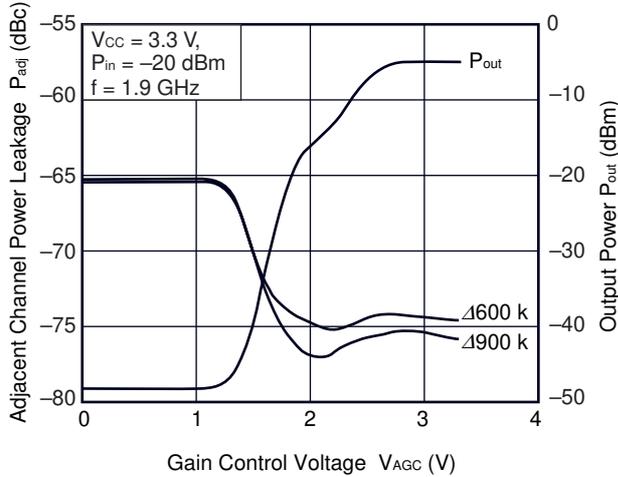


Remark The graphs indicate nominal characteristics.

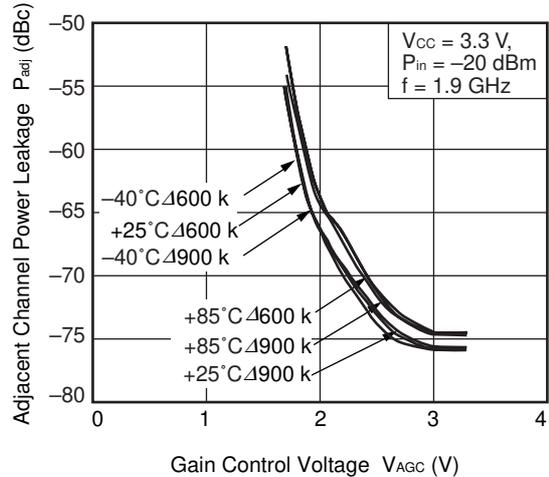


Remark The graphs indicate nominal characteristics.

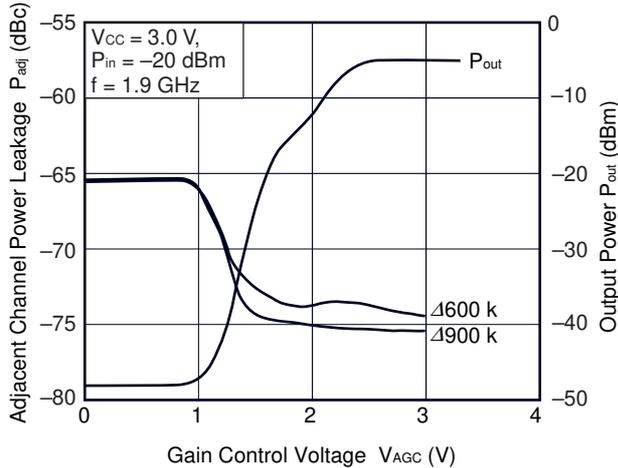
ADJACENT CHANNEL POWER LEAKAGE, OUTPUT POWER vs. GAIN CONTROL VOLTAGE



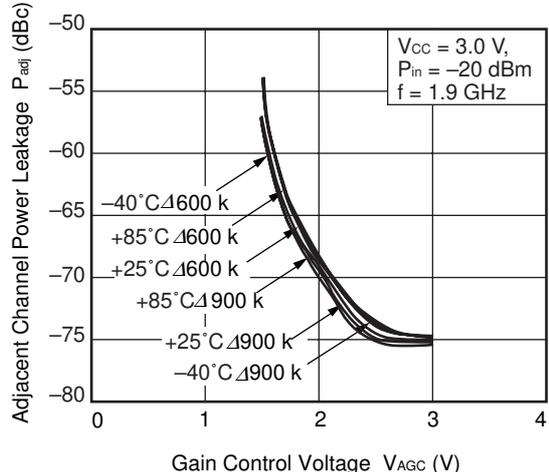
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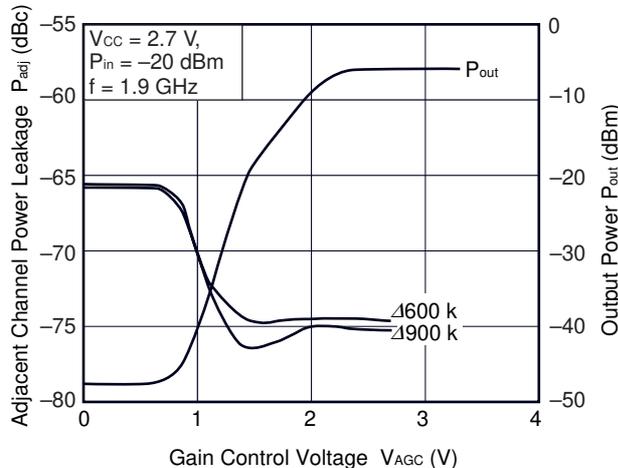
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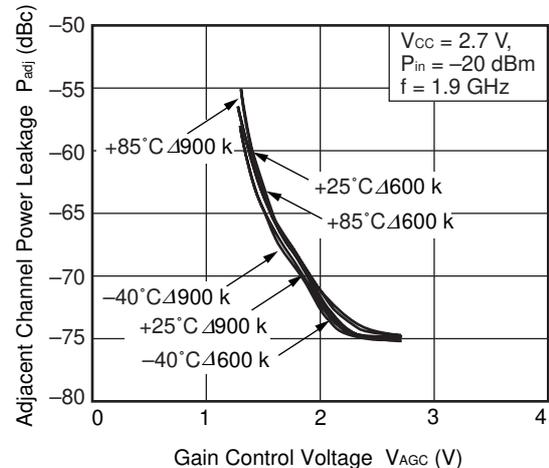
ADJACENT CHANNEL POWER LEAKAGE vs. GAIN CONTROL VOLTAGE



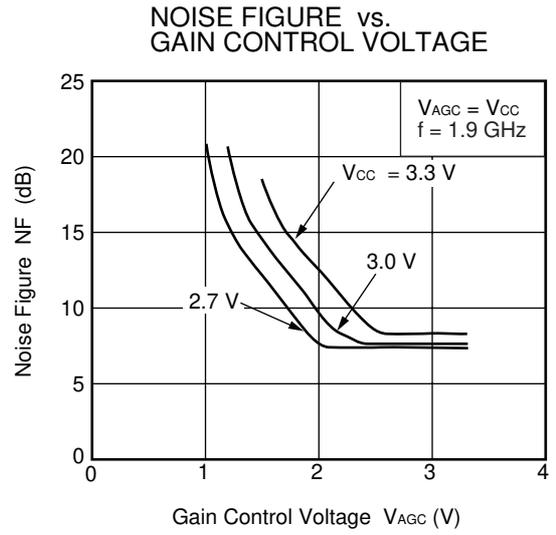
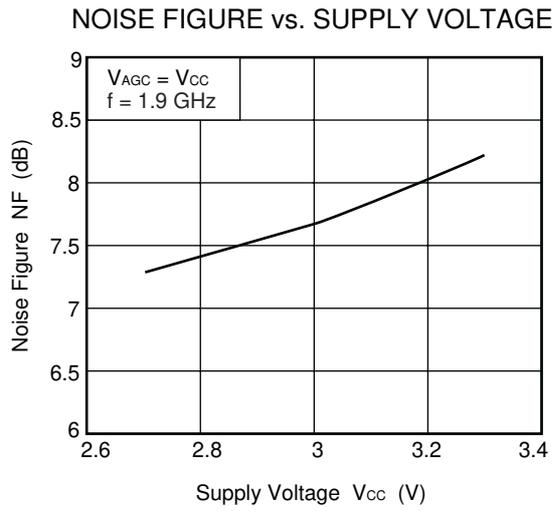
ADJACENT CHANNEL POWER LEAKAGE, OUTPUT POWER vs. GAIN CONTROL VOLTAGE



ADJACENT CHANNEL POWER LEAKAGE vs. GAIN CONTROL VOLTAGE

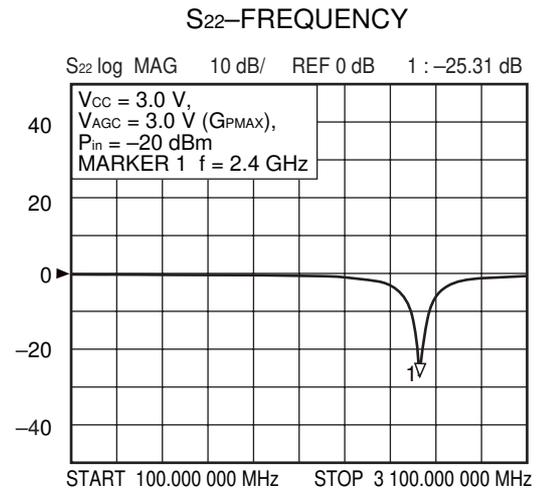
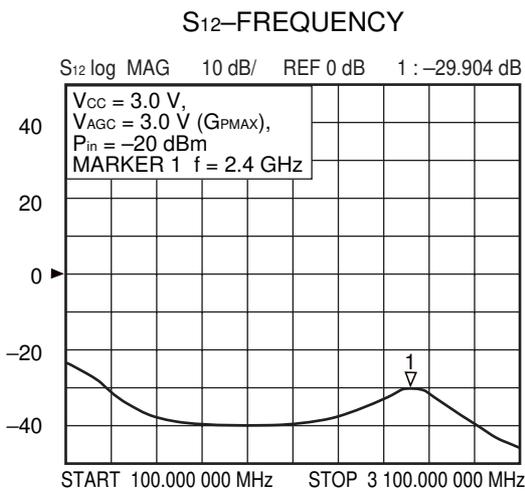
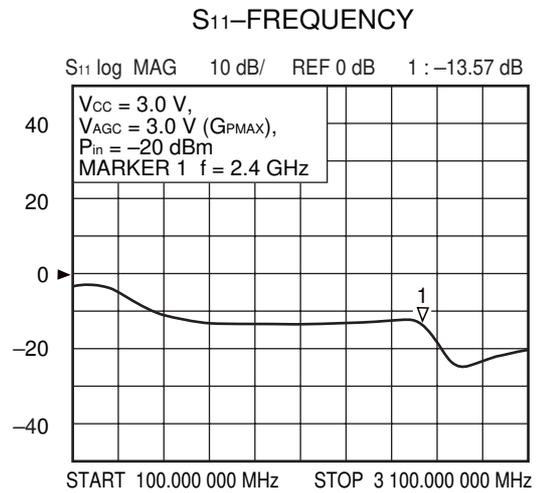
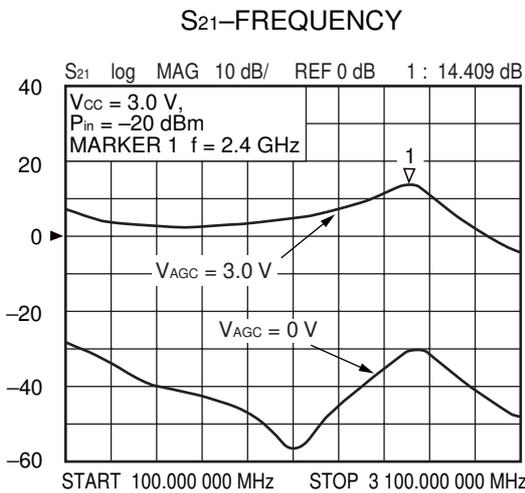
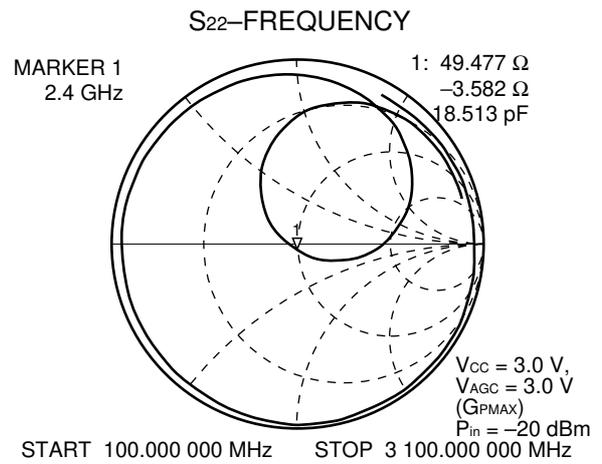
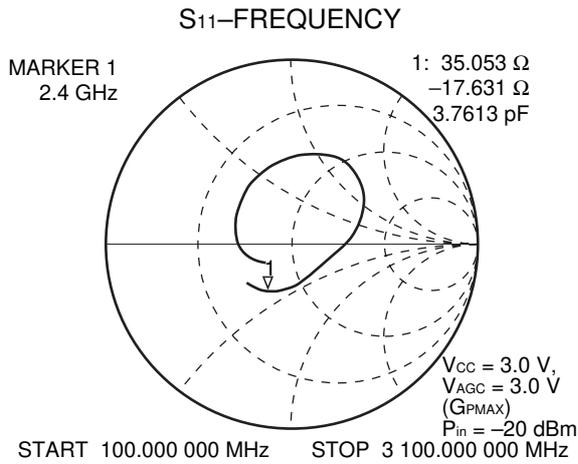


Remark The graphs indicate nominal characteristics.



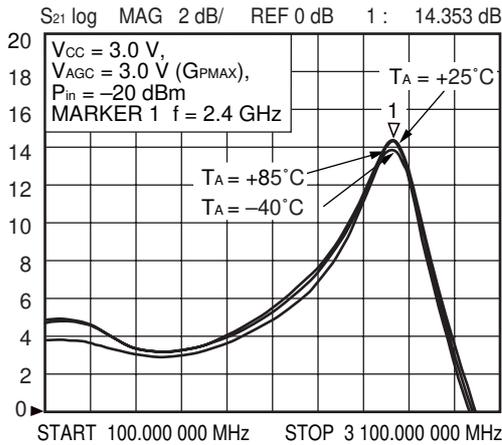
Remark The graphs indicate nominal characteristics.

6.3 Output port matching at f = 2.4 GHz

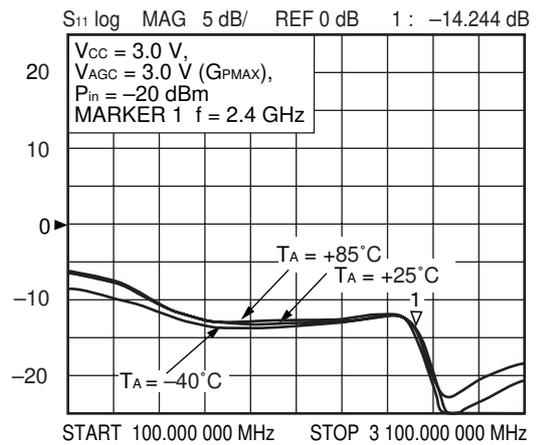


Remark The graphs indicate nominal characteristics.

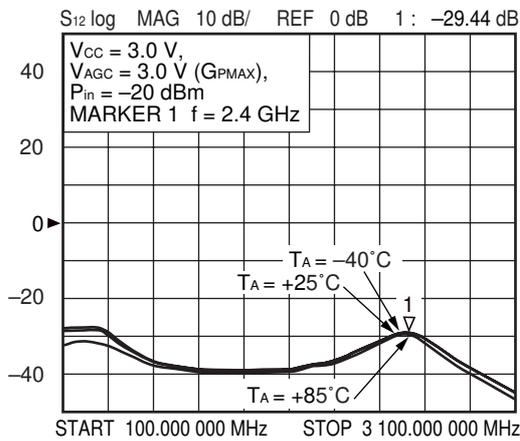
S₂₁-FREQUENCY



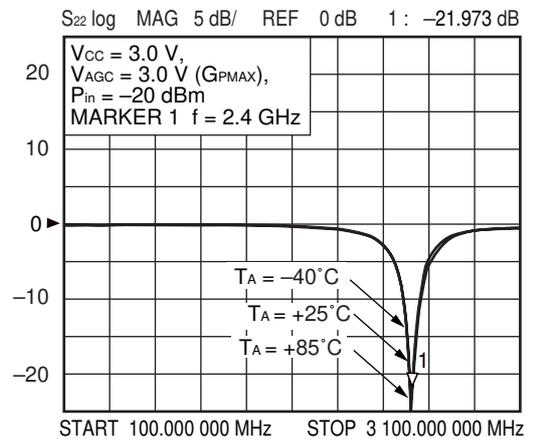
S₁₁-FREQUENCY



S₁₂-FREQUENCY

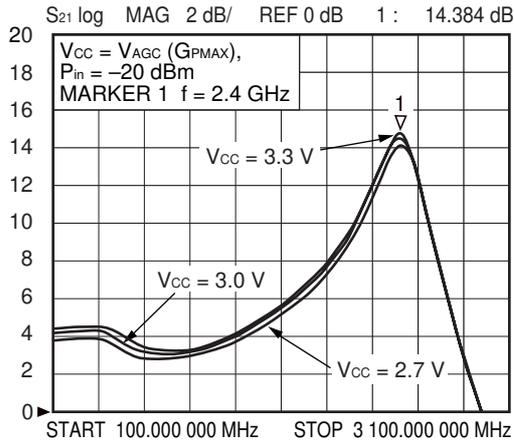


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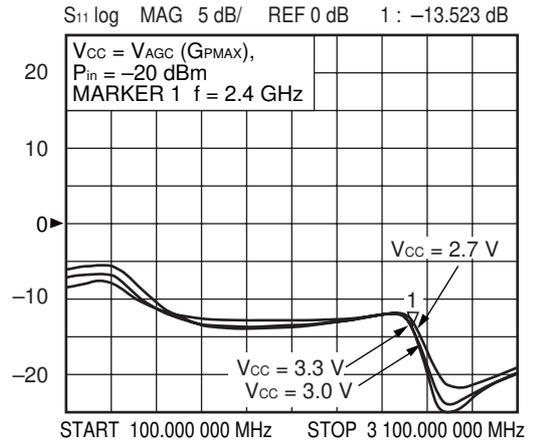


Remark The graphs indicate nominal characteristics.

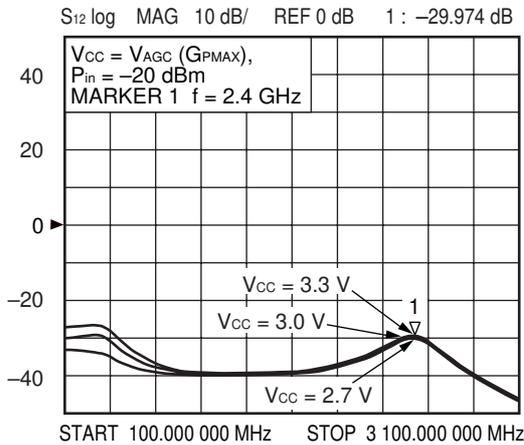
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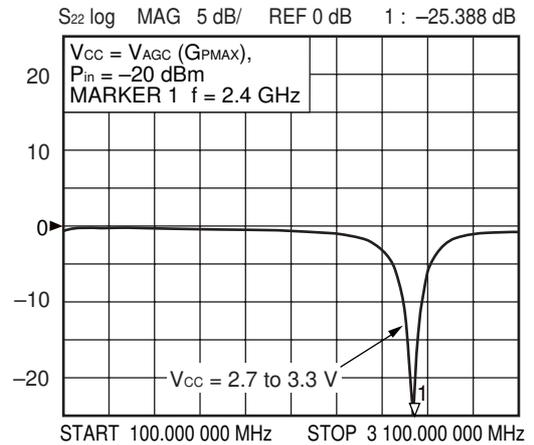
S₁₁-FREQUENCY



S₁₂-FREQUENCY

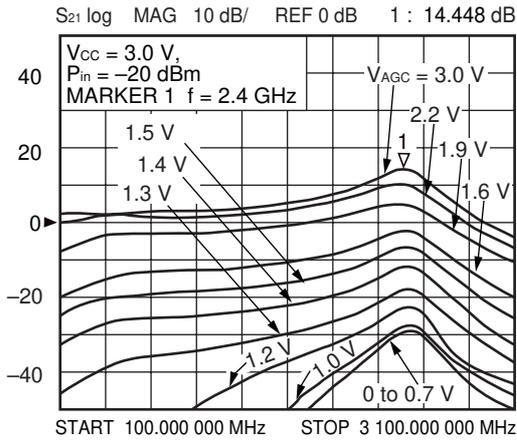


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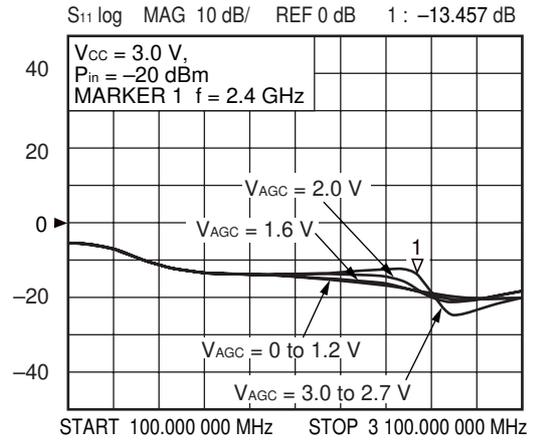


Remark The graphs indicate nominal characteristics.

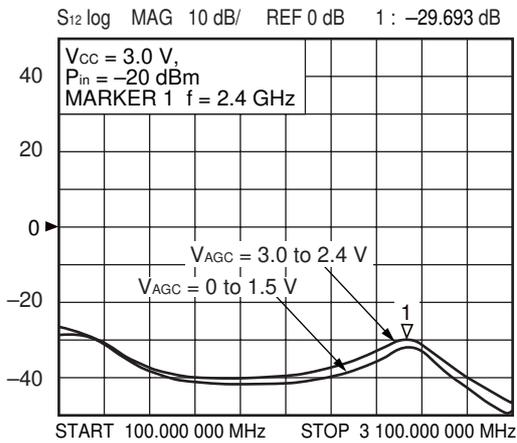
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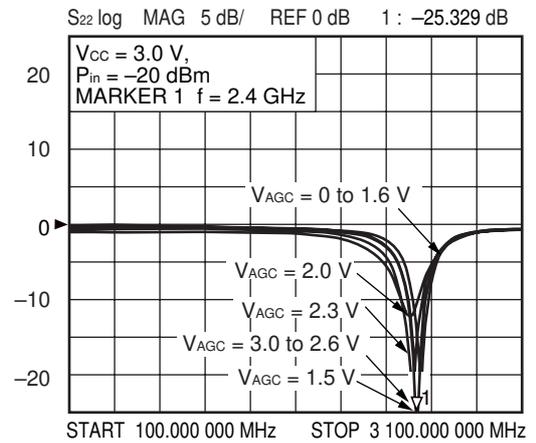
S₁₁-FREQUENCY



S₁₂-FREQUENCY



S₂₂-FREQUENCY



Remark The graphs indicate nominal characteristics.